

# Wafer-scale integration of 2D materials in high-density memristive crossbar arrays for artificial neural networks

---

**Mario Lanza<sup>1</sup>**

Shaochuan Chen<sup>1,2</sup>, Mohammad Reza Mahmoodi<sup>2</sup>, Yuanyuan Shi<sup>3</sup>, Chandreswar Mahata<sup>1</sup>, Bin Yuan<sup>1</sup>, Xianhu Liang<sup>1</sup>, Chao Wen<sup>1</sup>, Fei Hui<sup>4</sup>, Deji Akinwande<sup>5</sup>, Dmitri B. Strukov<sup>2</sup>,

<sup>1</sup> Institute of Functional Nano and Soft Materials (FUNSOM), Collaborative Innovation Center of Suzhou Nanoscience & Technology, Soochow University, 215123 Suzhou, China

<sup>2</sup> Electrical and Computer Engineering Department, University of California at Santa Barbara, Santa Barbara, CA 93106–9560, USA

<sup>3</sup> IMEC, Kapeldreef 75, B-3001 Heverlee (Leuven), Belgium

<sup>4</sup> Materials Science and Engineering Department, Technion – Israel Institute of Technology, Haifa 32000, Israel

<sup>5</sup> Microelectronics Research Center, Department of Electrical and Computer Engineering, The University of Texas at Austin, Austin, TX, USA

[mlanza@suda.edu.cn](mailto:mlanza@suda.edu.cn)

---

During the last decade, memristors have attracted enormous interest due to their excellent capability to store digital information, and they are being considered to be a key element to build future artificial neural networks for bio-inspired neuromorphic computing systems [1-5]. Recent works have shown that memristors made of layered two-dimensional (2D) materials can exhibit performances that traditional memristors (made of transition metal oxides) do not show, such as excellent transparency and flexibility, high-temperature stability, and unique controllability of the conductance potentiation, depression and relaxation [6-9]. However, all studies on 2D materials based memristors focused on single devices, and system level performances like yield and device-to-device variability have never been analyzed in depth. Furthermore, several basic properties of 2D materials based memristors (such as switching time, write energy, I-V non-linearity, and scalability) have never been investigated. In this talk, I will present the first wafer-scale statistical analysis of high-density memristive crossbar arrays made of 2D layered materials. By using chemical vapor deposited multilayer hexagonal boron nitride (h-BN) sheets, we have fabricated metal/h-BN/metal memristive crossbar arrays not only exhibit outstanding performance, but also high yield ~98%, and low device-to-device variability. These findings may accelerate the use of 2D materials for building wafer-scale and high-density electronic memories and artificial neural networks.

---

## References

---

- [1] Mario Lanza et al. *Advanced Electronic Materials*, 1800143 (2018).
- [2] Na Xiao et al. *Advanced Functional Materials*, 27, 1700384 (2017).
- [3] Kaichen Zhu et al. *ACS Applied Materials and Interfaces*, 11, 37999-38005, 2019.
- [4] Xu Jing et al. *2D Materials*, 6(3), 035021, 2019.
- [5] Yuanyuan Shi et al. *Nature Electronics* 1, 458–465 (2018).
- [6] Fei Hui et al. *2D Materials*, 5, 031011 (2018).
- [7] Fei Hui et al. *ACS Applied Materials & Interfaces* 9 (46), 39895-39900 (2017).
- [8] Lanlan Jiang et al. *ACS Applied Materials & Interfaces* 9 (45), 39758-39770 (2017).
- [9] Chengbin Pan et al. *2D Materials*, 4, 025099 (2017).